



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **G-0206-08** DATE: 6/17/2002
Product Affected: All square PQFP and TQFP packages
shipped in Tape and Reel

Date Effective: 9/17/2002

MEANS OF DISTINGUISHING CHANGED DEVICES:

- Product Mark
- Back Mark
- Date Code Starting ww38
- Other

Contact: Geoffrey Cortes
Title: Manager, Corporate Quality & Reliability Attachment: Yes No
Phone #: (408) 492-8321 See attachment for orientation details.
Fax #: (408) 727-2328 Samples: N/A
E-mail: Geoffrey.Cortes@idt.com

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process
- Assembly Process Pin 1 orientation of all square PQFP and TQFP packages shipped in Tape and Reel packaging will be changed to comply with current EIA Standards (EIA-481-2-A) requirement.
- Equipment
- Material
- Testing
- Manufacturing Site Additional label will be placed on the intermediate box (pizza box) to alert customer of this change. Please see attachment for details.
- Data Sheet
- Other - Packaging

RELIABILITY/QUALIFICATION SUMMARY:

There is no change to the product reliability

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____ ***Approval for shipments prior to effective date.***
Name/Date: _____ E-Mail Address: _____
Title: _____ Phone# /Fax# : _____

CUSTOMER COMMENTS:

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____ DATE: _____



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT - PCN #: G-0206-08

PCN Type: To comply to current EIA Standards (EIA-481-2-A) requirement.

Data Sheet Change: No

Detail of Change: This change will be implemented on all square PQFP and TQFP packages.

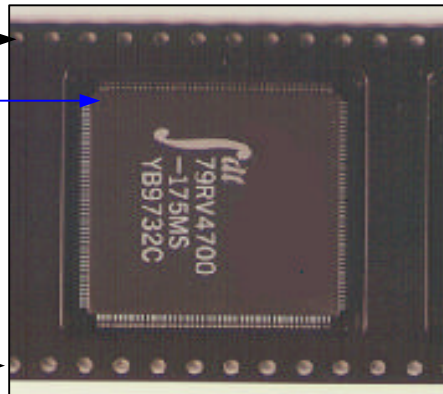
FROM:

Round Sprocket Holes

Electrical Pin# 1 and Dimple

User Direction of Unreeling

Elongated Sprocket Holes



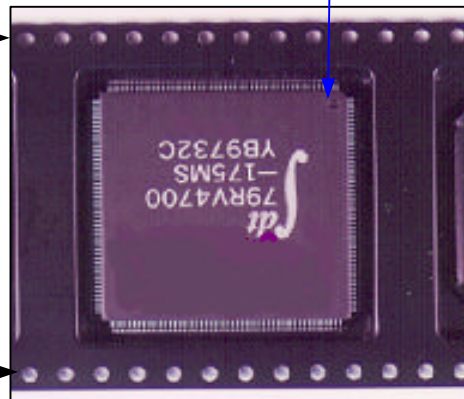
TO:

Round Sprocket Holes

User Direction of Unreeling

Elongated Sprocket Holes

Electrical Pin# 1 and Dimple



Conversion schedule:

Additional label will be placed on the intermediate box (pizza box) to alert customer of this change.
Label will be placed starting (ww38) 9/17/2002 until 9/17/2003.

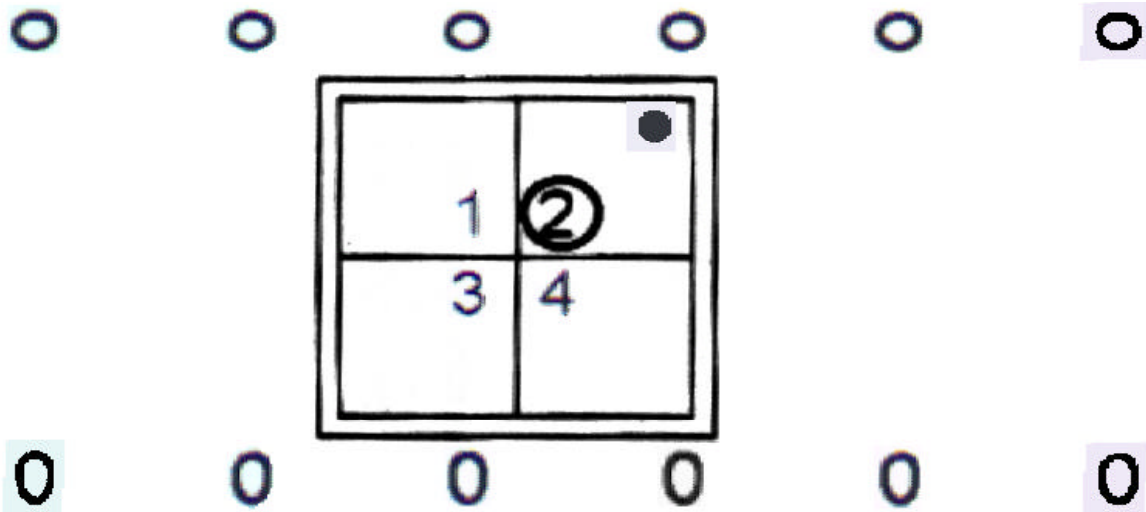


Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT - PCN #: G-0206-08

Additional label will be placed on the intermediate box (pizza box) to alert customer of this change.



● Pin One in Quadrant 2